

TOSHIBA Photocoupler Photorelay

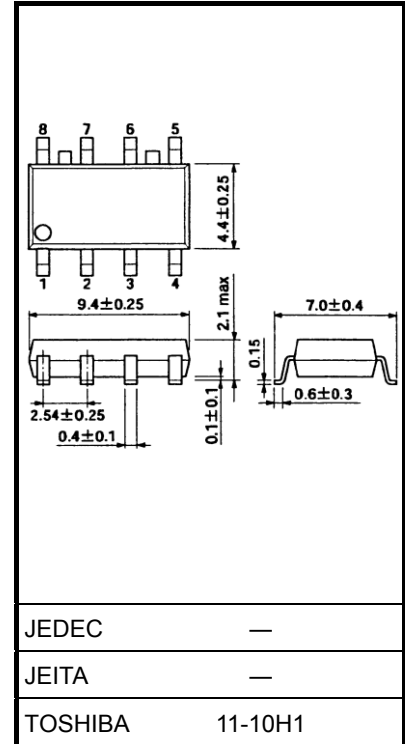
TLP4026G

Telecommunication
 Measuring Equipment
 Security Equipment
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The Toshiba TLP4026G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET and is the 1-form-A/B photorelay with 350-V withstanding voltage.

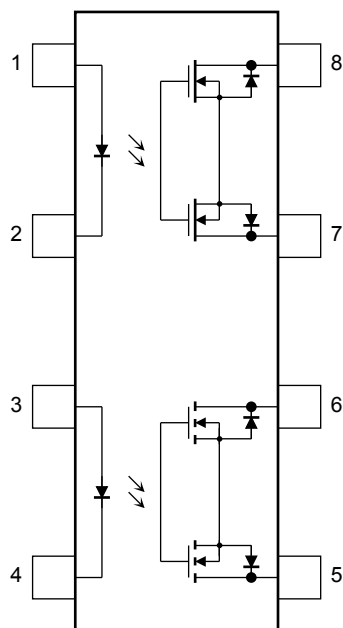
- Normally closed (1-form-B) device, normally opened (1-form-A) device
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 25 Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL approved: UL1577, File No.E67349

Unit: mm



Weight: 0.2 g (typ.)

Pin Configuration (top view)



- 1: Anode (1b)
- 2: Cathode (1b)
- 3: Anode (1a)
- 4: Cathode (1a)
- 5: Drain D1 (1a)
- 6: Drain D2 (1a)
- 7: Drain D3 (1b)
- 8: Drain D4 (1b)

Start of commercial production
 2002-08

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
LED	Forward current	I _F	50	mA	
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C	
	Peak forward current	I _{FP}	1	A	
	Reverse voltage	V _R	5	V	
	Diode power dissipation	P _D	50	mW	
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-0.5	mW/°C	
	Junction temperature	T _J	125	°C	
Detector	Off-state output terminal voltage	V _{OFF}	350	V	
	On-state current	One channel operation	I _{ON}	120	mA
		Two channel operations (1a1b simultaneous operation)			
	On-state current derating (Ta ≥ 25°C)	One channel operation	ΔI _{ON} /°C	-1.2	mA/°C
		Two channel operations (1a1b simultaneous operation)			
	Output power dissipation	P _O	370	mW	
	Output power dissipation derating (Ta ≥ 25°C)	ΔP _O /°C	-3.7	mW/°C	
Junction temperature	T _J	125	°C		
Storage temperature range	T _{stg}	-55 to 125	°C		
Operating temperature range	T _{opr}	-40 to 85	°C		
Lead soldering temperature (10 s)	T _{sol}	260	°C		
Isolation voltage (AC, 1 minute, R.H. ≤ 60%)	(Note 1) BV _S	1500	V _{rms}		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pins 1, 2, 3 and 4 are shorted together, and pins 5, 6, 7 and 8 are shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V _{DD}	—	—	280	V
Forward current	I _F	5	—	25	mA
On-state current	I _{ON}	—	—	120	mA
Operating temperature	T _{opr}	-20	—	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	I_R	$V_R = 5 \text{ V}$	—	—	10	μA
	Capacitance	C_T	$V_F = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	—	pF
Detector	Off-state current	I_{OFF}	$V_{OFF} = 350 \text{ V}$	—	—	1	μA
	Capacitance (1b)	C_{OFF}	$V = 0 \text{ V}, f = 1 \text{ MHz}, I_F = 5 \text{ mA}$	—	65	—	pF
	Capacitance (1a)		$V = 0 \text{ V}, f = 1 \text{ MHz}, I_F = 0 \text{ mA}$				

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Form	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	1a	I_{FT}	$I_{ON} = 120 \text{ mA}$	—	1	3	mA
	1b	I_{FC}	$I_{OFF} = 10 \mu\text{A}$				
Return LED current	1a	I_{FC}	$I_{OFF} = 10 \mu\text{A}$	0.1	—	—	mA
	1b	I_{FT}	$I_{ON} = 120 \text{ mA}$				
On-state resistance	—	R_{ON}	$I_{ON} = 120 \text{ mA}$ (Note 2)	—	15	25	Ω

Note 2: 1-form-A: $I_F = 5 \text{ mA}$, 1-form-B: $I_F = 0 \text{ mA}$

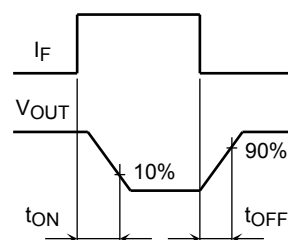
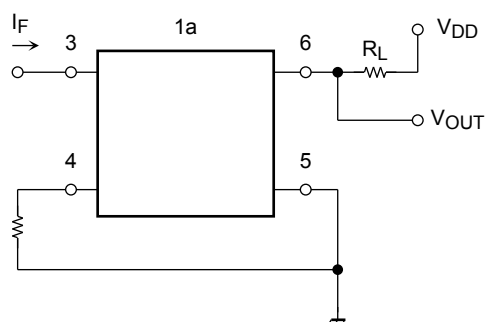
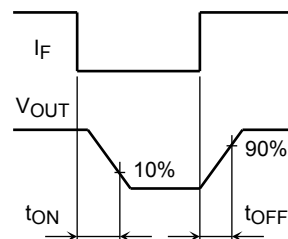
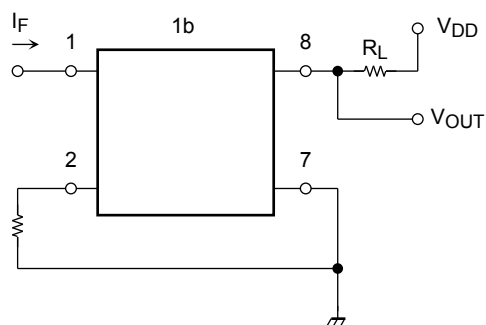
Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C_S	$V_S = 0 \text{ V}$, $f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}$, R.H. $\leq 60\%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 1 minute	1500	—	—	Vrms
		AC, 1 second, in oil	—	3000	—	Vrms
		DC, 1 minute, in oil	—	3000	—	Vdc

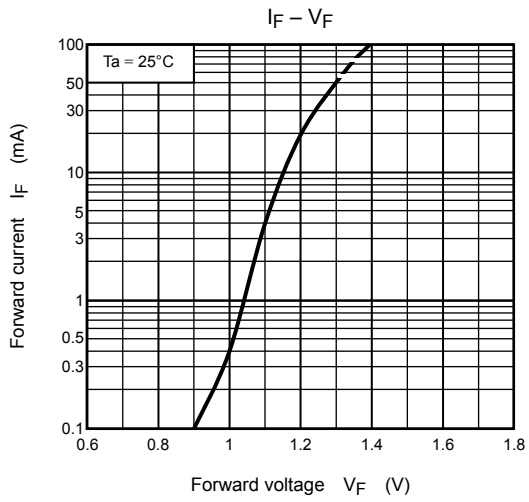
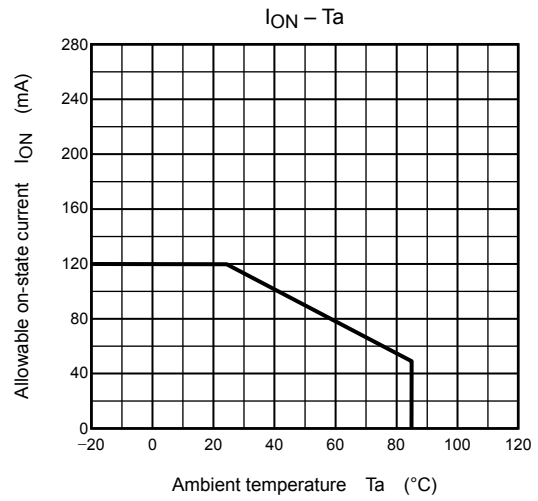
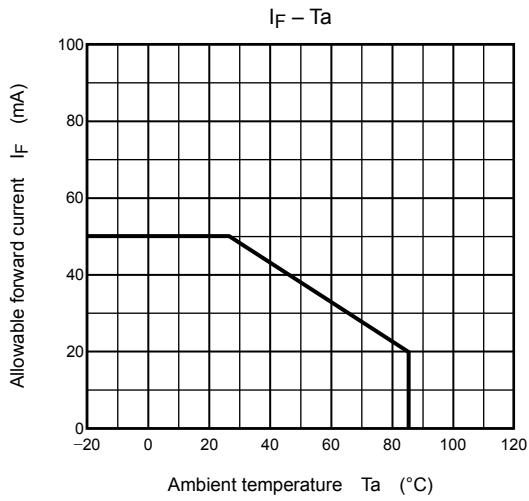
Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
1b	Turn-on time	t_{ON}	$R_L = 200 \Omega$ $V_{DD} = 20 \text{ V}$, $I_F = 5 \text{ mA}$ (Note 3)	—	—	1	ms
	Turn-off time	t_{OFF}		—	—	3	
1a	Turn-on time	t_{ON}	$R_L = 200 \Omega$ $V_{DD} = 20 \text{ V}$, $I_F = 5 \text{ mA}$ (Note 3)	—	—	1	ms
	Turn-off time	t_{OFF}		—	—	1	

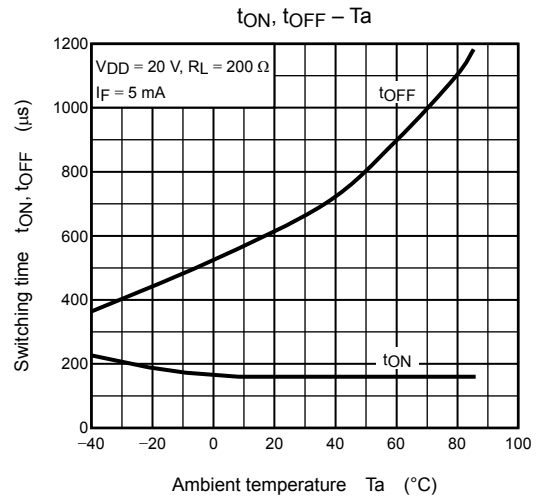
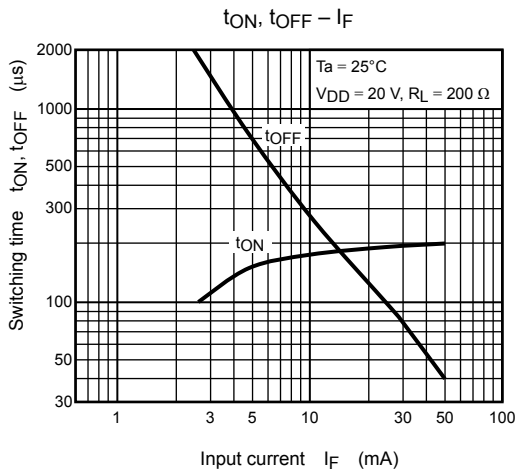
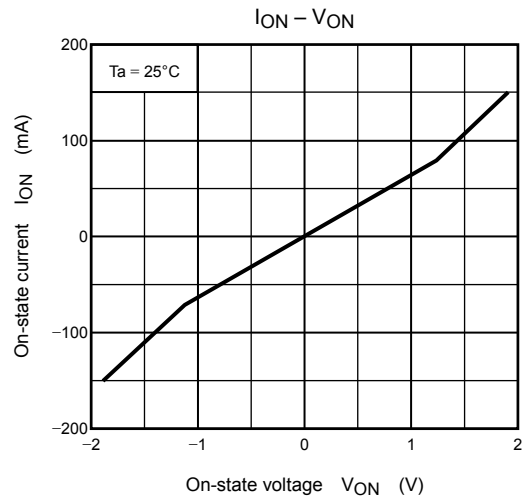
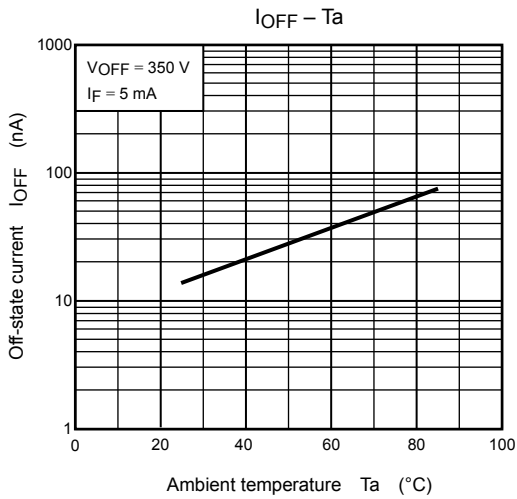
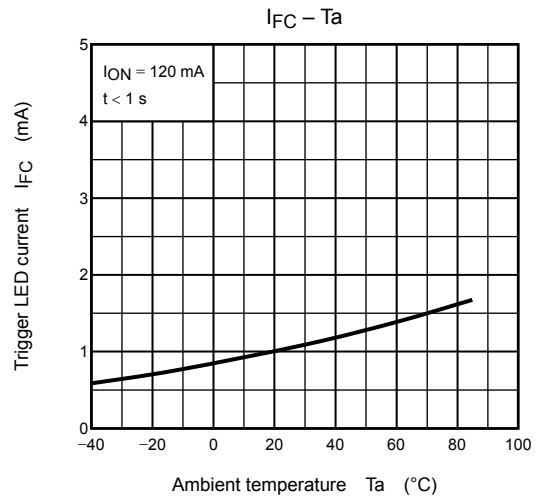
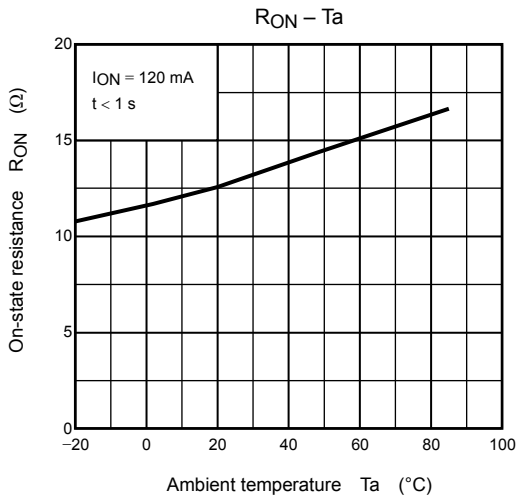
Note 3: Switching time test circuit



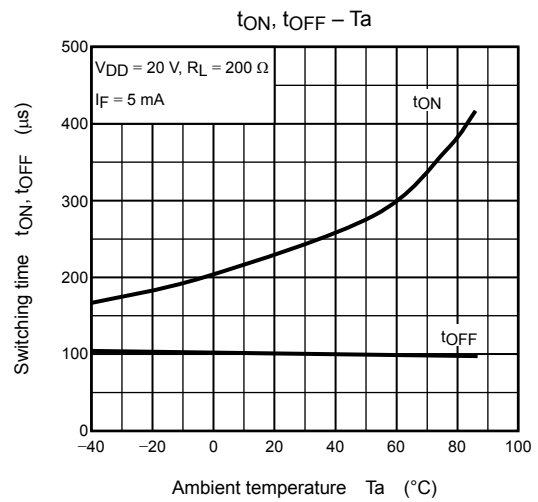
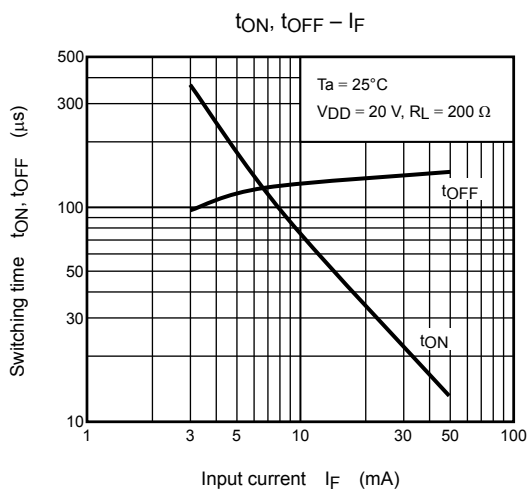
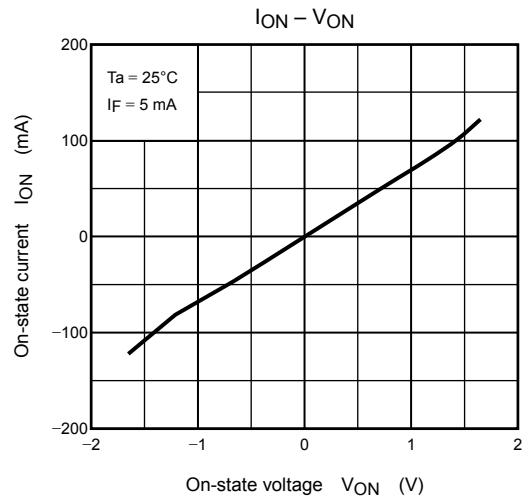
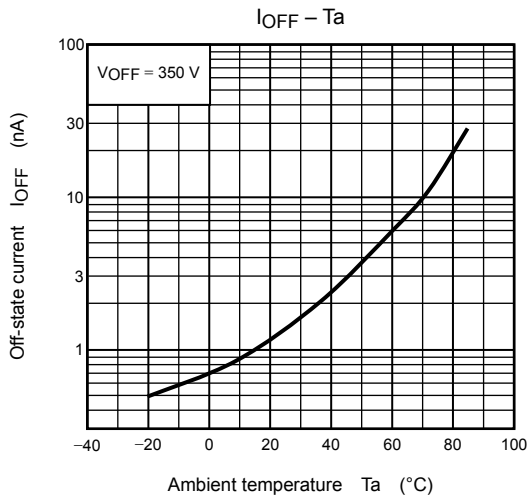
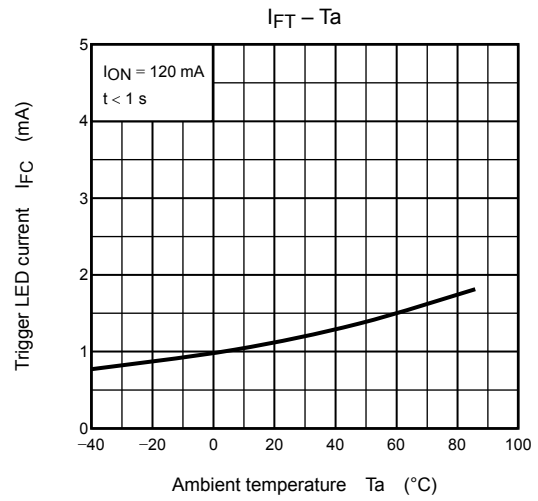
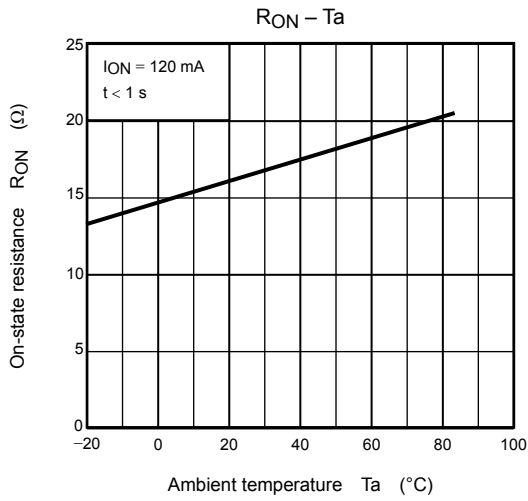
Characteristics curves for 1-form-A/B



Characteristics curves for 1-form-B



Characteristics curves for 1-form-A



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